

01/13/02  
O I P E  
MAR 21 2002  
PATENT & TRADEMARK OFFICE

Honeywell Docket No. H0001719 (4960)  
Practitioner Docket No. 100665.0042US1

COPY OF PAPERS  
ORIGINALLY FILED

H4/Election  
a

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
WASHINGTON, D.C. 20231

Inventor: **Johnson, et al.**  
Serial No: **09/933,596**  
Filed: **August 20, 2001**  
For: **Configurations and Methods  
for Improved Copper  
Distribution Uniformity in  
Printed Wiring Boards**

Examiner: Tuan T. Dinh  
Art Unit: 2827

4/11/02  
RECEIVED  
MAR 27 2002  
TECHNOLOGY CENTER 2800

RESPONSE TO OFFICE ACTION

The Honorable Commissioner  
of Patents and Trademarks  
Washington, D.C. 20231

Dear Sir:

This paper responds to the Office Action dated February 20, 2002. Please enter the following:

Restriction Requirement

The Applicant elects Group I, claims 1-10, without traverse.

In the Claims

Please cancel claims 11-20.

US 0993359609P1



Creation date: 09-12-2002  
Indexing Officer: FR1 - Formalities Review 1  
Team: CENTRALSCANPRINT  
Dossier: 09933596

Legal Date: 19-04-2002

No.	Doccode	Number of pages
1	SRFW	1

Total number of pages: 1

Remarks:

Order of re-scan issued on .....